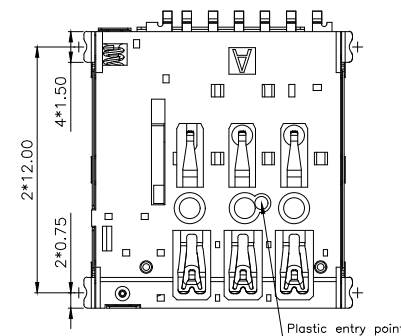
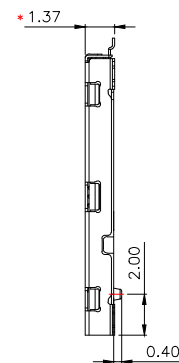
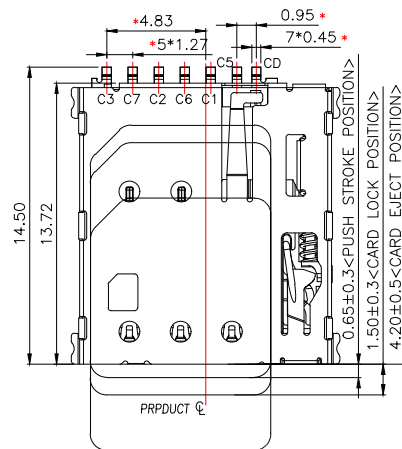
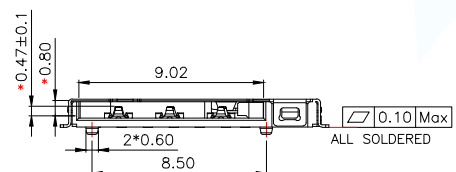
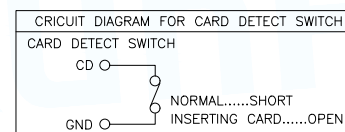


3D VIEW



PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O



NOTES:

1.MATERIAL:

HOUSING: High Temperature Thermoplastic

Terminal: Copper Alloy

Shell: Stainless Steel

2.PLATING:

Terminal:50u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

Shell:30u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

3.technical speciality:

RATED VOLTAGE: 30V AC MAX.

CURRENT RATING: 0.5A MAX.

INSULATION RESISTANCE:1000MΩ MIN

CONTACT REISTANCE:50mΩ MAX

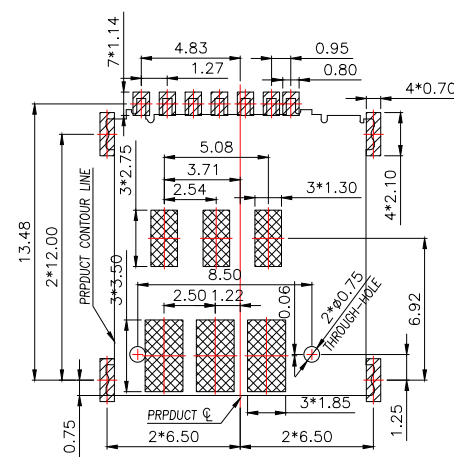
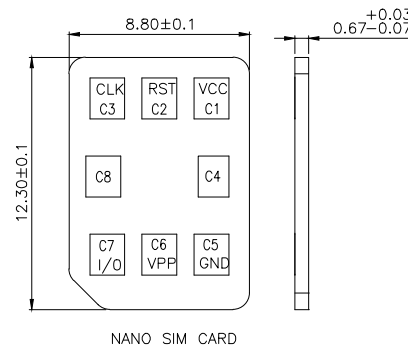
WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES

OPERATING TEMPERATURE: -40℃~+85℃

Humidity 80% R.H MAX

4.DIMENSIONS WITH MARK" * "MUST BE MEASURE

BY QC AND IPQC



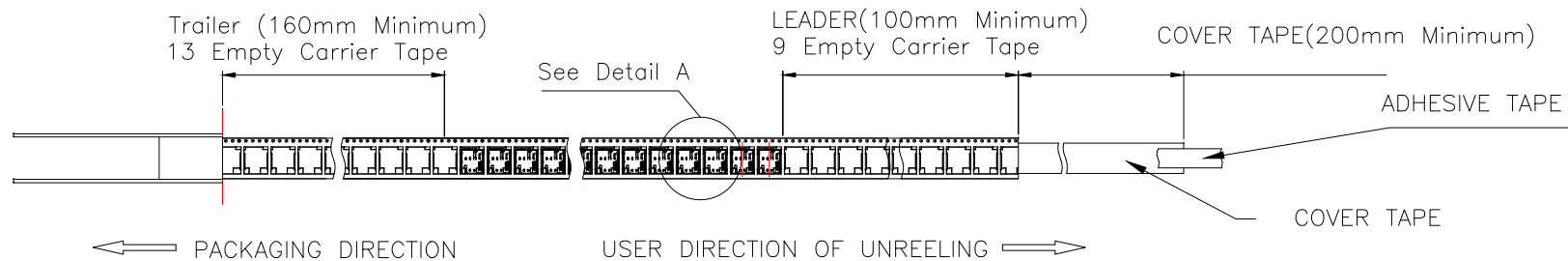
RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

RECOMMENDED MATAL MASK T=0.12mm

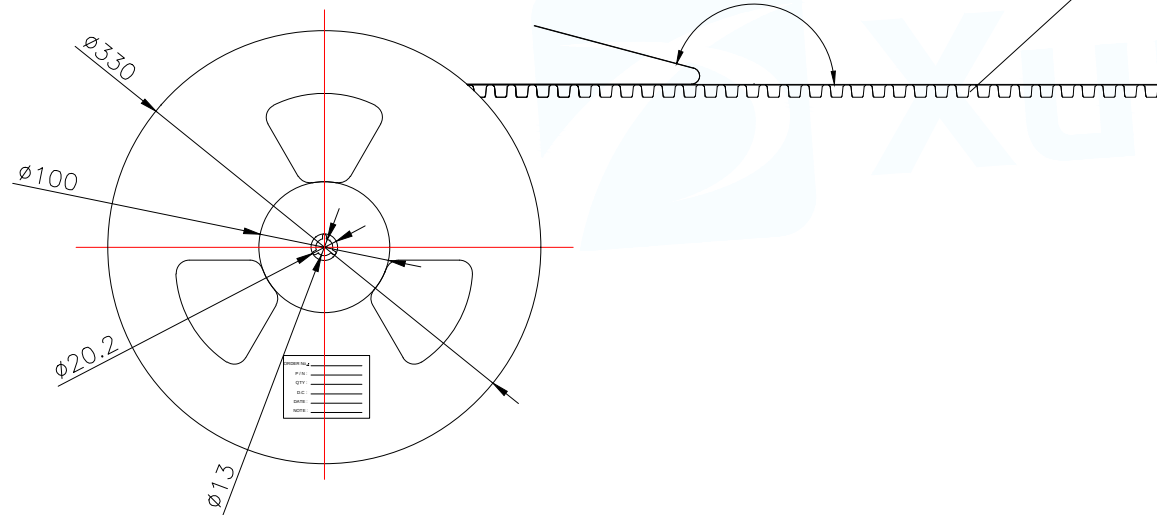
SMT SOLDER AREA

NO PATTERN AND VIA HOLE IN HTIS AREA

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:NANO SIM CARD 1.37H PUSH PUSH 有柱
			PAR SMN-303-ACP7
DECIMALS:	ANGLES:		DWN
X.:±0.35	X'.:±2'		CHKD
.X.:±0.15	.X':±1'		APVD
.XX:±0.10	.XX':±0.5'	CUSTOMER COPY	SCALE:1:1 UNIT:MM
			SIZE:A4 SHEET:1F1 REV:A

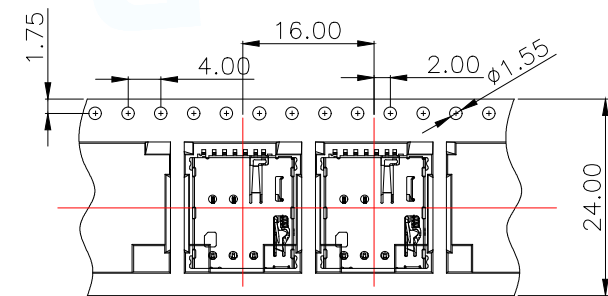


COVER TAPE PEELING ANGLE:165°~180°
PEELING FORCE:20~130g



PACKAGING DIRECTION ←

USER DIRECTION OF UNREELING →



DETAIL A

1	SMN-303-ACP7	1500	10		15000	350X350X340
ITEM	PRODUCT NO	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			
DECIMALS:	ANGLES:	TITLE:NANO SIM CARD 1.37H PUSH PUSH 有柱	
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.XX:±0.10	.XX':±0.5'	CHKD	
CUSTOMER COPY		APVD	
		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A